Terafence IoT Cyber Security

Email Relay for Air Gapped Networks

Where Every IoT Counts

Email is still considered as valid, useful communication method especially when the receiver is a human. Sending messages, errors, warning and as such is an operational requirement in OT environments, yet the traditional all safe keeping Air-Gap must be converged in order to deliver electronic messages from OT to external world.

Terafence secure email relay Solution keeps a Military grade network separation at the physical network layer and denies any attempt to reach the secured side. Unlike other datadiodes relying on optic fibers, Terafence have designed hardware chip to attain military grade protection.

Terafence Email-Relay Solution enables safely sending emails without any risk or exposure to outside Cyber threats, within an All-In-One compact desktop unit connected to both networks. The unit maintains the galvanic Air-Gap while forwarding data at 1Gbps from the secure side to the less secured side. No human intervention, no surprises.

Key Features:

- Total galvanic network separation
- Terafence proprietary hardware chip (FPGA)
- SMTP Email-Relay functionality (TLS)
- HTTP/S Simple GUI for unit configuration (from secure side only)
- Two accompanying CPUs for protocol support

Security features:

- Hardened Linux operating system on accompanying CPUs
- Core security hardware has no OS, no MAC/IP
- Secure unit access (HTTPS) to GUI for configuration

Technical Specification:

- 1Gbps data throughput
- Power 2x12-48VDC @60 Watt
- Network Ports 2xRJ-45 CAT5E ports
- No moving mechanical parts
- Measurements: 95 x 160 x 200 (mm)
- Desktop or DYN Rail mounting
- Operating temperature (-40) ~ (+80)^oC
- In-door use only



Email Relay for Air Gaped Networks

Solution Highlights:

- Total Galvanic, physical network separation, hardware based on proprietary CHIP
- Solution includes two accompanying CPUs for protocol support and termination
- Email-Relay, SMTP (over SSL/TLS)
- Simple, easy unit configuration using HTTPS GUI
- 1Gbps backplane

Terafence TFG121 technical specification

- Processor Intel [®] ATOM x5-E3940 CPU
- Memory Slim Bootloader 16 MiB Bios Memory LPDDR4 Dual Channel 1600MHz 8GB Storage
- Network 2 x Intel [®] I210-IT 10/100/1000 Mbps
- Ports 2 x USB 3.0 (external), 2 x USB 2.0 (PL2303)
- Approx 95 x 200 x 160 mm Dimensions

- All-in-One solution, no need for additional HW/SW supplements
- No hidden costs
- Small footprint, desktop or DYN rail mount.
- Stand-alone unit, not interacting with external entities
- No moving mechanical parts
- Approx 2 KG Weight Aluminum and Steel Construction
- Desktop, Din Rail, Wall-Mount Mounting
- -40 ~ 80°C Operating Temperature
- 95% @ 40°C non-condensing Relative Humidity
- CE & FCC Class B
- IEC62443-4-2 SL2
- MIL-STD-810F Method 516.5



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